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Silicon N-Channel MOS FET



ADE-208-1303 (Z) 1st. Edition Mar. 2001

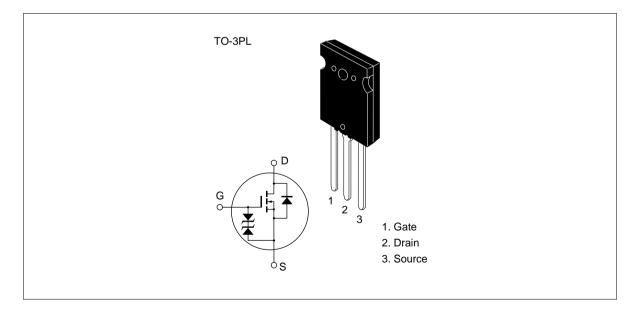
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1628	V _{DSS}	450	V
	2SK1629		500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	30	A
Drain peak current		L _{D(pulse)} *1	120	А
Body to drain diode reverse drain current		I _{DR}	30	A
Channel dissipation		Pch*2	200	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note 1. PW 10 µs, duty cycle 1%

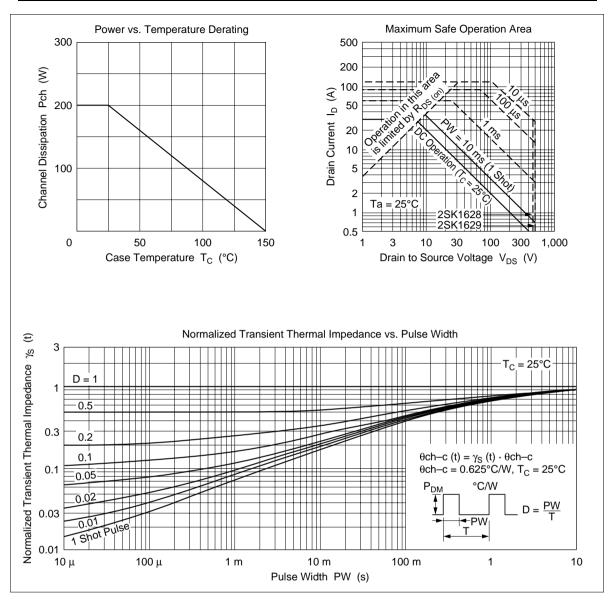
2. Value at $T_c = 25^{\circ}C$

Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1628	$V_{(\text{BR})\text{DSS}}$	450		_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
breakdown voltage	2SK1629	-	500	-			
Gate to source break	lown	$V_{(BR)GSS}$	±30	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak co	urrent	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage	2SK1628	I _{DSS}			250	μA	$V_{\rm DS} = 360 \text{ V}, \text{ V}_{\rm GS} = 0$
drain current	2SK1629	-					$V_{\rm DS} = 400 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
Static Drain to source	2SK1628	$R_{\text{DS(on)}}$		0.20	0.25		$I_{\rm D}$ = 15 A, $V_{\rm GS}$ = 10 V * ¹
on state resistance	2SK1629			0.22	0.27		
Forward transfer adm	ittance	yfs	12	20	_	S	$I_{\rm D}$ = 15 A, $V_{\rm DS}$ = 10 V * ¹
Input capacitance		Ciss		2800	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance		Coss		780	_	pF	f = 1 MHz
Reverse transfer capa	citance	Crss	_	90		pF	
Turn-on delay time		t _{d(on)}		32	_	ns	$I_{\rm D}$ = 15 A, $V_{\rm GS}$ = 10 V,
Rise time Turn-off delay time		t,		140	_	ns	$R_L = 2$
		$t_{d(off)}$		200	_	ns	
Fall time		t _f	_	100	_	ns	
Body to drain diode fo voltage	rward	V_{DF}	_	1.1	_	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode re recovery time	everse	t _{rr}	—	600	—	ns	$I_F = 30 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

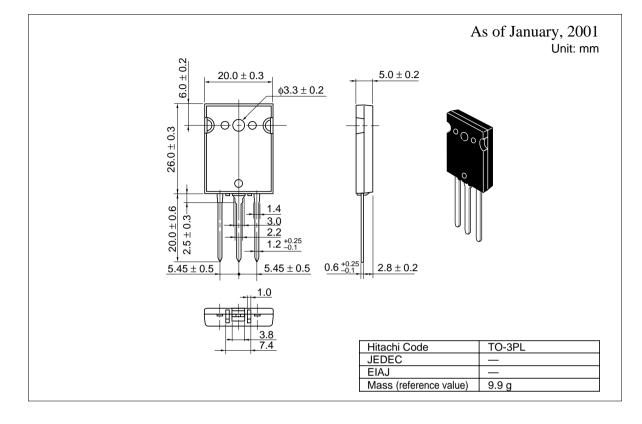
Electrical Characteristics (Ta = 25°C)

Note 1. Pulse test

See characteristics curves of 2SK1169, 2SK1170



Package Dimensions



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